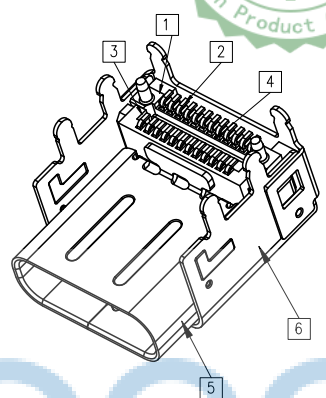
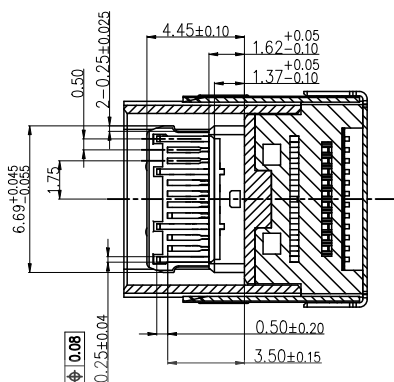
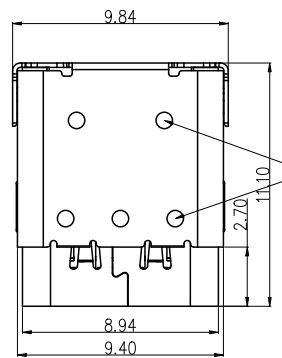


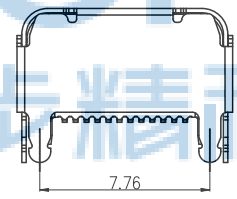
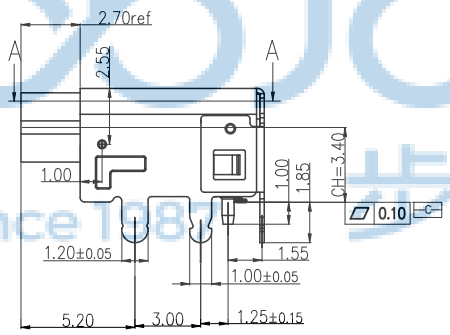
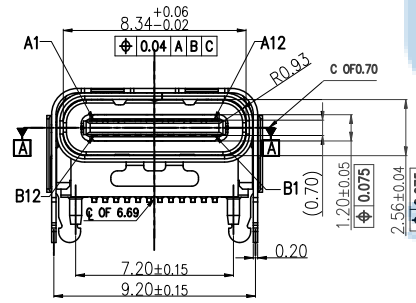


REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

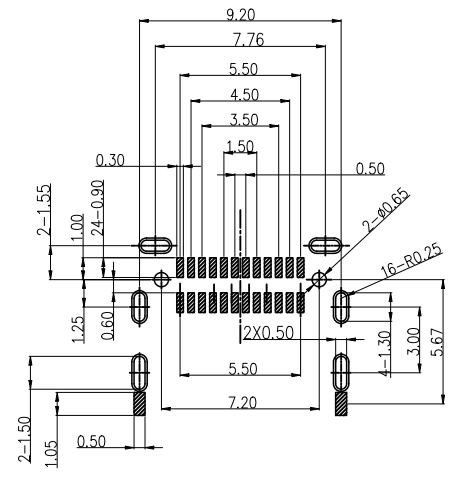
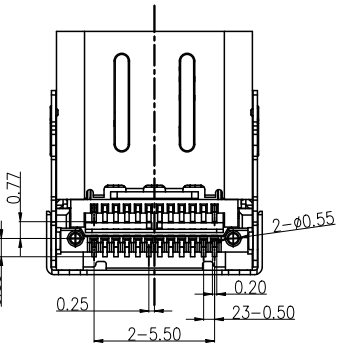


SECTION A-A

NOTES:
 1.MATERIAL :SEE TABLE
 2.COPLANARITY : 0.10 Max.
 3.ELECTRICAL CHARACTERISTICS
 LOW LEVEL CONTACT RESISTANCE: 40mΩ Max
 INSULATION RESISTANCE:100MΩ MIN
 DIELECTRIC WITHSTANDING VOLTAGE:100 VAC:
 CONTACT CURRENT RATING:5A Max
 4.MECHANICAL CHARACTERISTICS
 INSERTION FORCE: 5~20N
 EXTRACTION FORCE: 8~20N
 AFTER DURABILITY EXTRACTION FORCE: 6~20N
 5.DURABILITY: 10000 CYCLES
 6.PACKAGING TYPE: CARRIER TAPE.
 7.SALT SPRAY : 24 HOURS



Pin No	Signal Name	Mating Sequence	Pin No	Signal Name	Mating Sequence
A1	GND	First	B12	GND	First
A2	TX1+	Second	B11	RX1+	Second
A3	TX1-	Second	B10	RX1-	Second
A4	Vbus	First	B9	Vbus	First
A5	CC1	Second	B8	SBU2	Second
A6	D+	Second	B7	D-	Second
A7	D-	Second	B6	D+	Second
A8	SBU1	Second	B5	CC2	Second
A9	Vbus	First	B4	Vbus	First
A10	RX2-	Second	B3	TX2-	Second
A11	RX2+	Second	B2	TX2+	Second
A12	GND	First	B1	GND	First



RECOMMENDED P.C.B LAYOUT (COMPONENT SIDE)
PCB THICKNESS: 2.0±0.05mm



ITEM	DESCRIPTION	Q'TY	MATERIAL	FINISH
6	OUTER-SHELL	1	STAINLESS STEEL	SOLDER NICKEL: 50U" MIN
5	INNER-SHELL	1	STAINLESS STEEL	SOLDER NICKEL: 50U" MIN
4	TOP TERMINAL	1	COPPER ALLOY	MATING AREA: AU 3u" SOLDER TAIL: MATTE TIN 100 MIN, 50u" NICKEL OVERALL.
3	BOTTOM TERMINAL	1	COPPER ALLOY	MATING AREA: AU 3u" SOLDER TAIL: MATTE TIN 100 MIN, 50u" NICKEL OVERALL.
2	MID PLATE	1	STAINLESS STEEL	SOLDER NICKEL: 50U" MIN
1	MAIN HOUSING	1	HIGH TEMPERATURE	BLACK

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PDWG.NO: 0900-1

DR. TSP

APPD. JM_Zheng

CHKD. LYX

NAME: TYPE-C 24P 母座 双壳 垫高型 不短路款 双排SMT 镀金3u 板上六脚插 PH3.0 L=11.10 CH=3.40

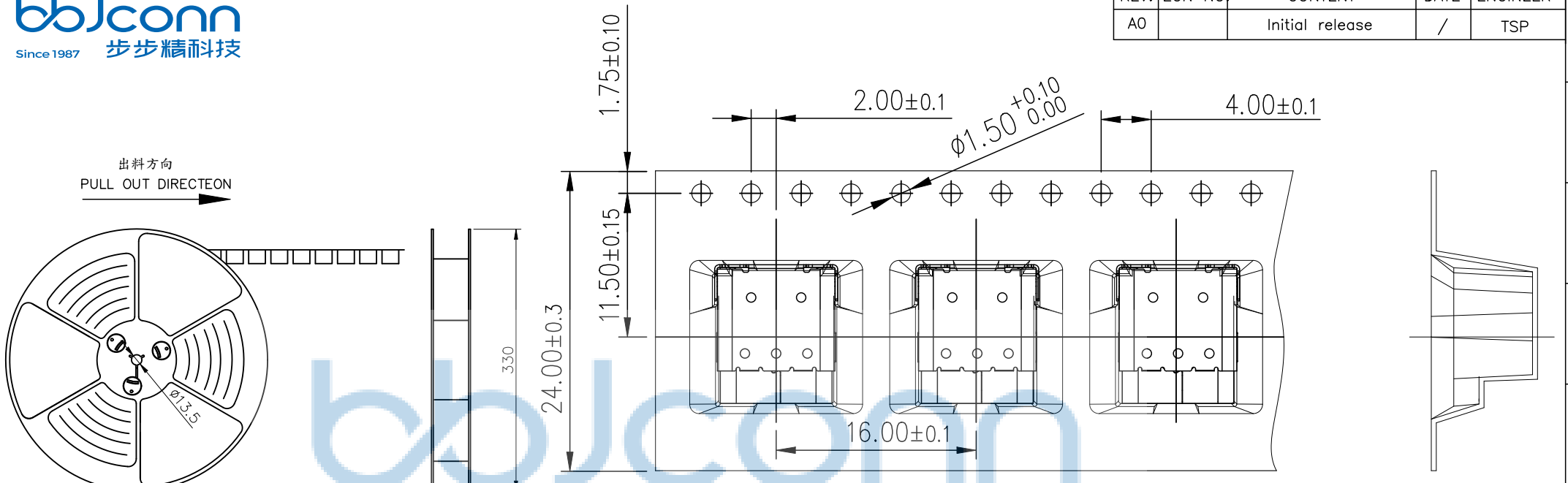
PJ. NO.: 126-221-240001-J8G

SIZE: A4 DRW NO.:

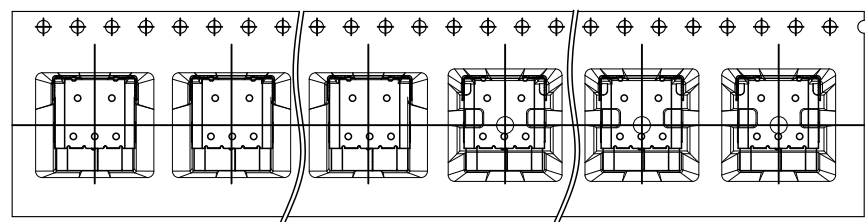
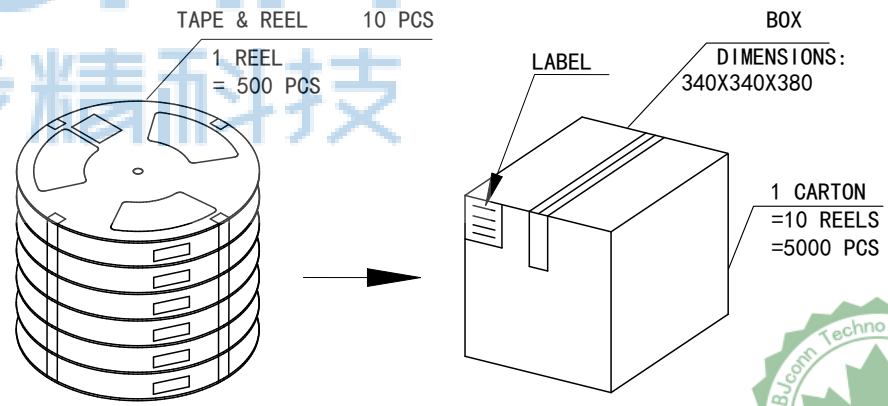
FINISH: SEE NOTES MAT'L.: SEE NOTES

SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/2

REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



出料方向
PULL OUT DIRECTEON



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APPD.	JM_Zheng	PJ. NO.: 126-221-240001-J8G SIZE: A4 DRW NO.:	NAME: TYPE-C 24P 母座 双壳 垫高型 不短路款 双排SMT 镀金3u 板上六脚插 PH3.0 L=11.10 CH=3.40
CHKD.	LYX		FINISH: SEE NOTES MAT'L.: SEE NOTES
PDWG.NO:	0900-1	DR.	TSP
		SCALE: N/A	REV.: A0 UNIT: mm PAGE: 2/2